



PCB LAYOUT

SPECIFICATIONS

- 1、Current Rating: 2A AC, DC
- 2、Voltage Rating: 250V AC, DC
- 3、Temperatuer Range: -25°C~+85°C
- 4、Contact Resistance: 20mΩ Max
- 5、Insulation Resistance: 1000MΩ Min
- 6、Withstanding Voltang: 800V AC/minute
- 7、Material: Wafer Nylon66, UL94V-0
PIN Brass Tin-plated

PIN	尺寸(mm)	
	A	B
02	2.00	6.00
03	4.00	8.00
04	6.00	10.00
05	8.00	12.00
06	10.00	14.00
07	12.00	16.00
08	14.00	18.00
09	16.00	20.00
10	18.00	22.00
11	20.00	24.00
12	22.00	26.00
16	30.00	34.00

凱帛企業有限公司 KABO ENTERPRISE CO.,LTD.		
Name 2.0 Wafer DIP R/A 無鹵料+2.0環保料		
Drawing No WF-2.0-2029-xx91R2		
DR	-	APPD
General Tolerances: x.xx± x.x±	Unit: mm	Scale: ROM